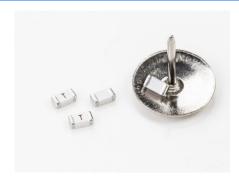








SolidMatrix® Surface Mount Fuses SB Series (Slow Blow), 1206 Size



Clearing Time Characteristics:

% of current rating	Clearing time at 25°C	
100%	4 hours min.	
200%	1 second min.	120 seconds max.
300%	0.1 seconds min.	3 seconds max.
800%	0.002 seconds min.	0.05 seconds max.

Agency Approval:

Recognized Under the Components Program of UL. File Number: E232989.

Patents:

Patent numbers "US6,034,589", "US6,602,766", "US7,268,661

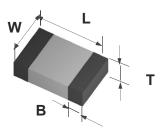
"ZL201210020693.1"

Features:

- High inrush current withstanding capability
- Multilayer monolithic structure with glass ceramic body and silver fusing element
- Silver termination with nickel and pure-tin solder plating, providing excellent solderability
- Compatible with both wave and reflow soldering processes
- Operating temperature range: -55°C to +150°C (with derating)

Shape and Dimensions:

Unit	Inch	mm
L	0.126 ± 0.008	3.20 ± 0.20
W	0.063 ± 0.008	1.60 ± 0.20
Т	0.038 ± 0.008	0.97 ± 0.20
В	0.020 ± 0.010	0.51 ± 0.25



Ordering Information:

Part Number	Current Rating (A)	Voltage Rating (VDC)	Interrupting Ratings	Nominal Cold DCR (Ω) ¹	Nominal I ² t (A ² s) ²	Marking Code ³
F1206SB1000V063TM	1.0	63		0.360	0.11	Е
F1206SB1250V063TM	1.25	63	50 A at rated voltages	0.200	0.22	F
F1206SB1500V063TM	1.5	63		0.150	0.23	G
F1206SB2000V063TM	2.0	63		0.088	0.63	
F1206SB2500V032TM	2.5	32		0.065	0.90	J
F1206SB3000V032TM	3.0	32		0.034	1.20	K
F1206SB3500V032TM	3.5	32	voitages	0.028	1.60	L
F1206SB4000V032TM	4.0	32		0.024	2.20	M
F1206SB4500V032TM	4.5	32		0.020	3.60	Т
F1206SB5000V032TM	5.0	32		0.018	5.30	N
F1206SB5500V024TM	5.5	24		0.014	6.40	U
F1206SB6000V024TM	6.0	24	60 A at rated voltage	0.011	8.50	0
F1206SB7000V024TM	7.0	24		0.010	10.0	Р
F1206SB8000V024TM	8.0	24		0.009	16.9	R

^{1.} Measured at \leq 10% rated current and 25°C ambient.

^{2.} Melting I²t at 0.001 second pre-arcing time.

^{3.} Red Marking Character Code.



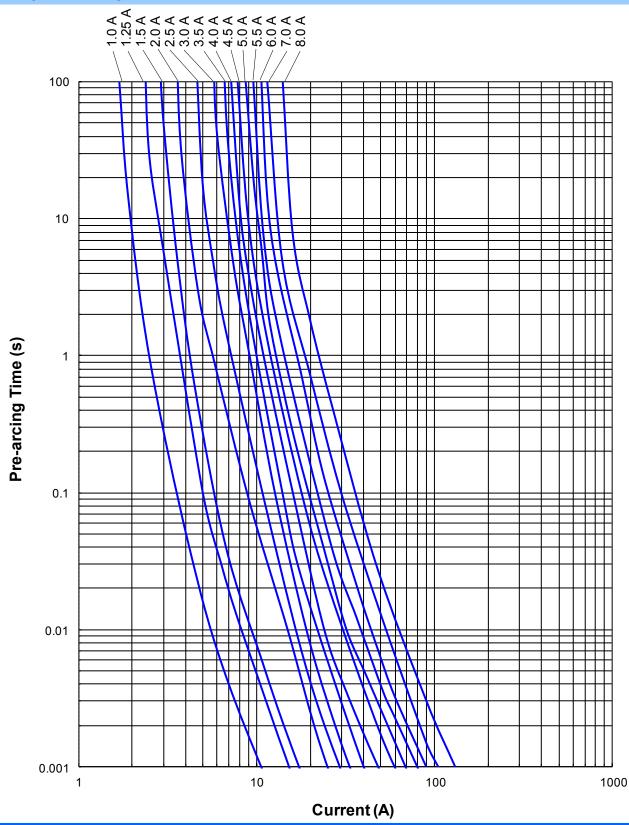






SolidMatrix® Surface Mount Fuses SB Series (Slow Blow), 1206 Size

Average Pre-arcing Time Curves:





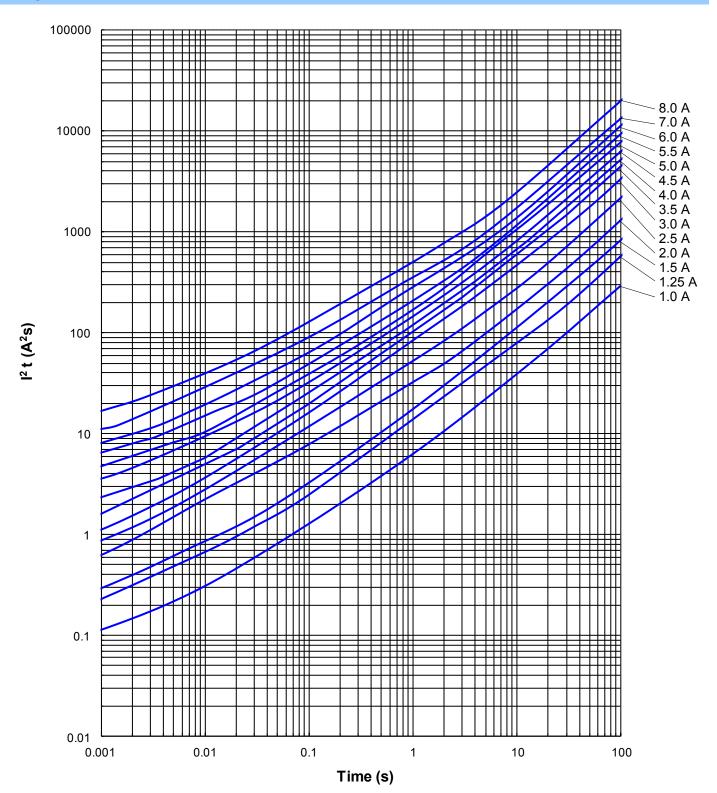






SolidMatrix[®] Surface Mount Fuses SB Series (Slow Blow), 1206 Size

Average I²t vs. t Curves:











SolidMatrix® Surface Mount Fuses

Product Identification:

F 0603 FA 1000 V032 T M

(1) (2) (3) (4) (5) (6) (7)

(1) Product Code: F-Chip Fuse

(2) Size Code: Standard EIA Chip Sizes

(3) Series Code: FA - Fast Acting, SB - Slow Blow,
HI - High Inrush, FF - Very Fast Acting, HB - High Current

(4) Current Rating Code: 1000 - 1000 mA (For HB, 10 - 10A)

(5) Voltage Rating Code: V032 - 32 VDC(6) Package Code: T - Tape & Reel, B - Bulk

(7) Marking Code: M - With Marking

F 1206 HC 20A0 T M

(1) (2) (3) (4) (5) (6)

(1) Product Code: F—Chip Fuse

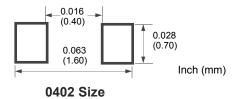
(2) Size Code: L x W (inch), the first two digits-L (length), the last two digits-W (width)

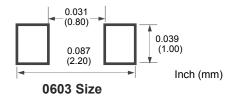
(3) Series Code: HC Series

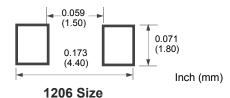
(4) Current Rating Code: 20A0—20.0A(5) Package Code: T - Tape & Reel, B - Bulk

(6) Marking Code: M - With Marking

Recommended Land Pattern:







Environmental Tests:

No.	Test	Requirement	Test condition	Test reference
1	Soldering heat resistance	DCR change ≤ ±10% No mechanical damage	One dip at 260°C for 60 seconds	MIL-STD-202 Method 210
2	Solderability	Minimum 95% coverage	One dip at 245°C for 5 seconds	MIL-STD-202 Method 208
3	Thermal shock	DCR change ≤ ±10% No mechanical damage	100 cycles between -65°C and +125°C	MIL-STD-202 Method 107
4	Moisture resistance	DCR change ≤ ±15% No excessive corrosion	10 cycles	MIL-STD-202 Method 106
5	Salt spray	DCR change $\leq \pm 10\%$ No excessive corrosion	48 hour exposure	MIL-STD-202 Method 101
6	Mechanical vibration	DCR change $\leq \pm 10\%$ No mechanical damage	0.4 " D.A. or 30 G between 5 – 3000 Hz	MIL-STD-202 Method 204
7	Mechanical shock	DCR change ≤ ±10% No mechanical damage	1500 G, 0.5 ms, half-sine shocks	MIL-STD-202 Method 213
8	Life	No electrical "opens" during testing voltage drop change shall be less than $\pm 20\%$ of initial value	80% rated current (75% for < 1 A fuses) for 2000 hours at ambient temperature between +20°C and +30°C	Refer to AEM QIQ106









SolidMatrix[®] Surface Mount Fuses

Electrical Specification:

Clearing Time Characteristics:

Same as specified on the Short Form Data Sheet

Insulation Resistance after Opening:

20,000 ohms typical when cleared with rated voltage applied. Fuse clearing under low voltage conditions may result in lower after clearing insulation resistance values. (Note: Under normal fault conditions (low or rated voltage conditions), AEM SolidMatrix fuses provide sufficient after clearing insulation resistance values for circuit protection.) **Current Carrying Capacity:**

100% rated current at +25°C ambient for 4 hours minimum when evaluated per MIL-PRF-23419

Interrupt Ratings:

Same as specified in this catalog.

Fuse Selection and Temperature De-rating Guideline:

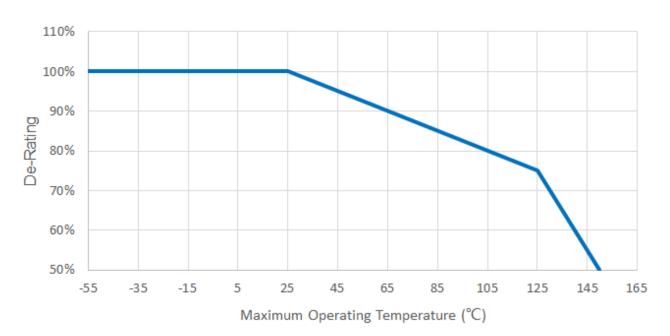
The ambient temperature affects the current carrying capacity of fuses. When a fuse is operating at a temperature higher than 25°C, the fuse shall be "de-rated".

To select a fuse from the catalog, the following rule may be followed:

Catalog Fuse Current Rating = Nominal Operating Current / 0.75 / % De-rating at the maximum operating temperature.

Example: At maximum operating temperature of 65°C, % De-rating is 90%. The nominal operating current is 4 A. The current rating for fuse selected from the catalog shall be: 4 / 0.75 / 90% = 5.9 or 6 A. Specifications and descriptions in this literature are as accurate as known at the time of publish, but are subject to change without notice.

Temperature De-Rating Curve for SolidMatrix Fuses







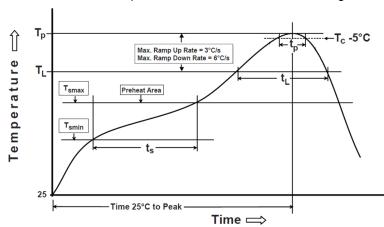




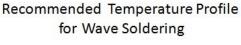
SolidMatrix[®] Surface Mount Fuses

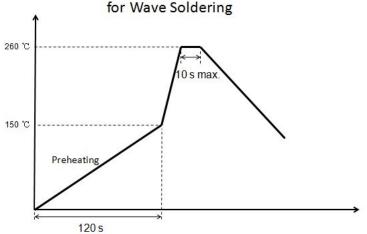
Soldering Temperature Profile:

* Recommended Temperature Profile for Reflow Soldering



^{*} Recommended Temperature Profile for Wave Soldering





Notice: Wave Soldering is suitable for 1206 and 0603 size.

Profile Feature	Pb-Free Assembly
$\label{eq:preheat/Soak} \begin{split} & \text{Preheat/Soak} \\ & \text{Temperature Min } (T_{\text{smin}}) \\ & \text{Temperature Max} (T_{\text{smax}}) \\ & \text{Time}(t_s) \text{ from } (T_{\text{smin}} \text{ to } T_{\text{smax}}) \end{split}$	150°C 200°C 60~120 seconds
Ramp-uprate (T _L to T _p)	3°C/second max.
$\begin{array}{c} \text{Liquidous temperature}(T_L) \\ \text{Time}(t_L) \text{ maintained above } T_L \end{array}$	217°C 60~150 seconds
Peak package body temperature (T _p)	260°C
Time $(t_p)^*$ within 5°C of the specified classification temperature (T_c)	30 seconds *
Ramp-down rate (T _p to T _L)	6°C/second max.
Time 25°C to peak temperature	8 minutes max.

^{*} Tolerance for peak profile temperature (Tp) is defined as a supplier minimum and a user maximum

Packaging:

Chip Size	Parts on 7 inch (178 mm) Reel
0402 (1005)	10,000
0603 (1608)	4,000
0603FF (1608)	6,000
1206 (3216)	3,000







Disclaimer

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